## AMPMODU | AMPMODU System 50

TE Internal #: 103916-6

PCB Mount Header, Vertical, Board-to-Board, 16 Position, 1.27 mm [.05 in] Centerline, Unshrouded, Gold, Through Hole - Solder,

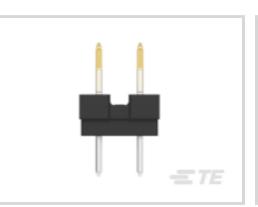
AMPMODU System 50

View on TE.com >

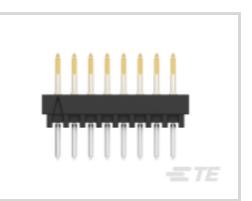


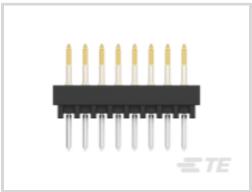
Connectors > PCB Connectors > PCB Headers & Receptacles











PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 16

Number of Rows: 2

### **Features**

## **Product Type Features**

| PCB Connector Assembly Type       | PCB Mount Header      |
|-----------------------------------|-----------------------|
| Connector System                  | Board-to-Board        |
| Header Type                       | Unshrouded            |
| Sealable                          | No                    |
| Connector & Contact Terminates To | Printed Circuit Board |

# **Configuration Features**

| Connector Contact Load Condition | Fully Loaded |
|----------------------------------|--------------|
| PCB Mount Orientation            | Vertical     |
| Number of Positions              | 16           |
| Number of Rows                   | 2            |
| Board-to-Board Configuration     | Parallel     |

## **Body Features**

| Primary Product Color | Black  |  |
|-----------------------|--------|--|
| Timary Troduct Color  | Diddit |  |

### **Contact Features**



| Contact Mating Area Plating Material           | Gold                       |
|--|----------------------------|
| Contact Mating Area Plating Material Thickness | .76 μm[30 μin]             |
| Contact Type                                   | Pin                        |
| Contact Current Rating (Max)                   | 3.6 A                      |
| Termination Features                           |                            |
| Rectangular Termination Post & Tail Thickness  | 3.6 mm                     |
| Termination Method to Printed Circuit Board    | Through Hole - Solder      |
| Mechanical Attachment                          |                            |
| Mating Alignment                               | Without                    |
| PCB Mount Retention                            | Without                    |
| PCB Mount Alignment                            | Without                    |
| Connector Mounting Type                        | Board Mount                |
| Housing Features                               |                            |
| Centerline (Pitch)                             | 1.27 mm[.05 in]            |
| Housing Material                               | LCP                        |
| Dimensions                                     |                            |
| Row-to-Row Spacing                             | 2.54 mm[.1 in]             |
| PCB Thickness (Recommended)                    | 1.57 mm[.062 in]           |
| Usage Conditions                               |                            |
| Housing Temperature Rating                     | High                       |
| Operating Temperature Range                    | -65 – 105 °C[-85 – 221 °F] |
| Operation/Application                          |                            |
| Circuit Application                            | Signal                     |
| Industry Standards                             |                            |
| UL Flammability Rating                         | UL 94V-0                   |
| Packaging Features                             |                            |
| Packaging Type                                 | Box, Tube                  |
|  |                            |

# **Product Compliance**

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU | Not Compliant |  |
|------------------------------|---------------|--|
|------------------------------|---------------|--|



| EU ELV Directive 2000/53/EC                   | Compliant with Exemptions  |
|---|--|
| China RoHS 2 Directive MIIT Order No 32, 2016 | Restricted Materials Above Threshold   |
| EU REACH Regulation (EC) No. 1907/2006        | Current ECHA Candidate List: JUNE 2023 (235)  Candidate List Declared Against: JUNE 2023 (235)  SVHC > Threshold:  Pb (13% in Component Part)  Article Safe Usage Statements:  Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location. |
| Halogen Content                               | Low Halogen - Br, Cl, F, I < 900 ppm per<br>homogenous material. Also BFR/CFR/PVC<br>Free  |
| Solder Process Capability                     | Wave solder capable to 260°C   |

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**





Also in the Series | AMPMODU System 50





# Customers Also Bought















# **Documents**

## **Product Drawings**

16 SYSTEM 50 HDR DRST UNSHRD

English

### **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_103916-6\_S.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_103916-6\_S.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_103916-6\_S.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

PCB Mount Header, Vertical, Board-to-Board, 16 Position, 1.27 mm [.05 in] Centerline, Unshrouded, Gold, Through Hole - Solder, AMPMODU System 50



Product Specifications

Application Specification

English